

Excellent Integrated System Limited

Stocking Distributor

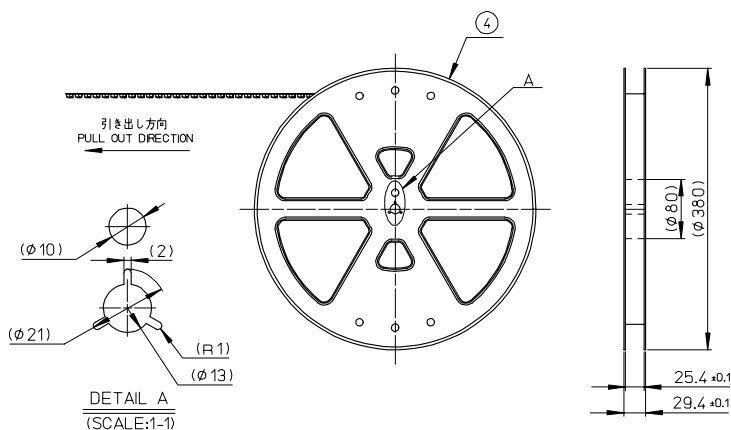
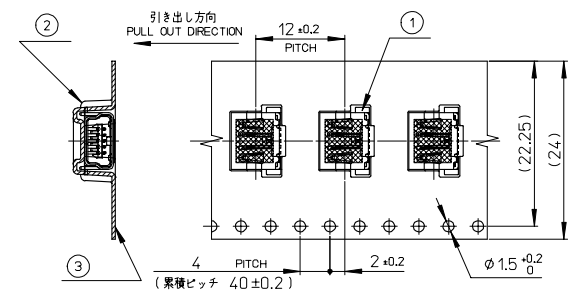
Click to view price, real time Inventory, Delivery & Lifecycle Information:

[Molex Connector Corporation](#)
[0513870530](#)

For any questions, you can email us directly:

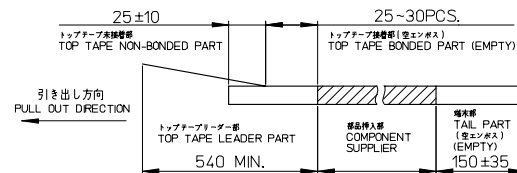
sales@integrated-circuit.com

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

DETAIL A
(SCALE:1-1)エンボステープ内の製品の向き
DIRECTION OF PRODUCT
IN EMBOSSED TAPE
(SCALE:2-1)

注記

- コネクタ詳細は SD-51387-006を参照下さい。
REFER TO SD-51387-006
- 梱包数量: 1200個/リール
NUMBER OF CONNECTOR: 1200 PCS/REEL
- リードテープ長さ
LEAD TAPE LENGTH



- トップテープの剥離強度: 0.6 ± 0.35 N (60 ± 35 gf)
<剥離速度: 300mm/min (参考)> (剥離方向は下図参照)
PEEL-OFF FORCE OF TOP TAPE: 0.6 ± 0.35 N (60 ± 35 gf)
(PEELING DIRECTION AS SHOWN IN FOLLOWING FIG.)
<PEEL-OFF SPEED: 300mm/min (REF.)>

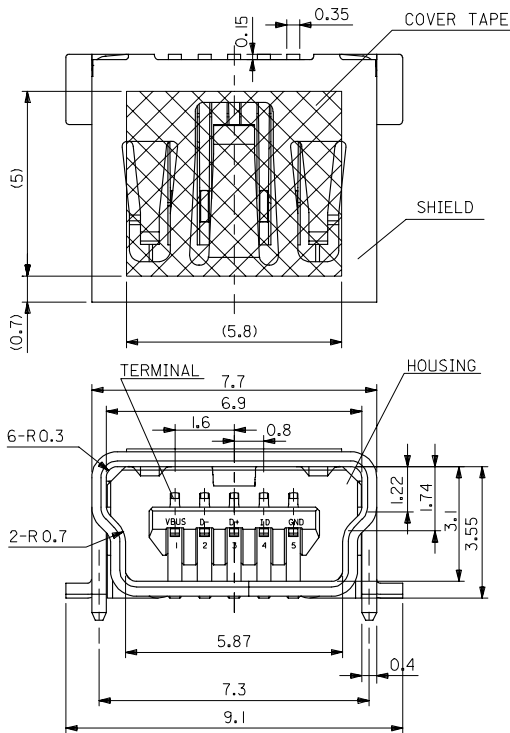


- 材料
MATERIAL
キャリアテープ: ポリプロピレン
CARRIER TAPE: POLYPROPYLENE
トップテープ: ポリエステル, ポリエチレン
TOP TAPE: POLYESTER, POLYETHYLENE
リール: ポリスチレン
REEL: POLYSTYREN

51387-0530	51387-***0
製品番号 MATERIAL No.	MODEL No.

RELEASED 2004/08/30 2004/08/30 2004/08/30 2004/09/02	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY	SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
		10 UNDER	± 0.2	DRAWN BY MSHINYAMA	DATE 04/07/18	EMBOSSD TAPE PKG. FOR 51387-0539 -LEAD FREE-		
		10 OVER 30 UNDER	± 0.25	CHECKED BY HTAKASE	DATE 04/07/18			
		30 OVER	± 0.3	APPROVED BY JMIYAZAWA	DATE 04/07/18	MOLEX MOLEX INCORPORATED		
		ANGULAR	± 3 °	MATERIAL NO.	DOCUMENT NO.			
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-51387-005		SHEET NO. 1 OF 1
REV	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

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注記
NOTES

1. 材質

MATERIAL

ハウジング: 耐熱樹脂 ガラス充填, 黒色, UL94V-0
HOUSING: HEAT RESISTANT PLASTIC,
GLASS FILLED, BLACK, UL94V-0
ターミナル: 銅合金 (t=0.25)
TERMINAL: COPPER ALLOY (t=0.25)
シールド: 銅合金 (t=0.4)
SHIELD: COPPER ALLOY (t=0.4)
カバー テープ: ポリイミド (t=0.08)
COVER TAPE: POLYIMIDE (t=0.08)

2. メッキ仕様

PLATING

ターミナル

TERMINAL

シールド

SHIELD

接点部: 金メッキ

CONTACT AREA: GOLD

半田付け部: 錫メッキ

SOLDER TAIL AREA: TIN

下地部: ニッケルメッキ

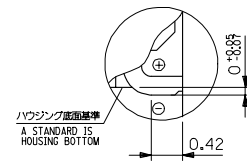
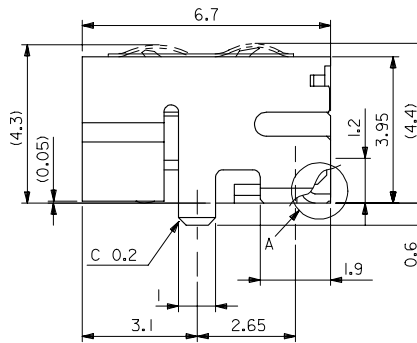
UNDER PLATING: NICKEL

下地部: ニッケル

UNDER PLATING: NICKEL

3. 平坦度は0.1mm MAX.

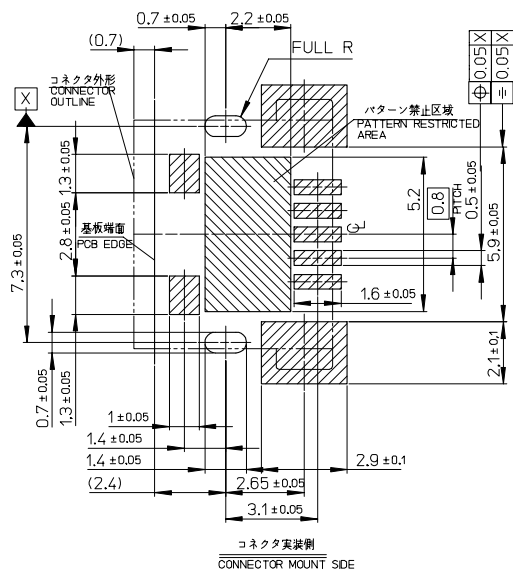
COPLANARITY 0.1mm MAX.



DETAIL A
(SCALE 20:1)

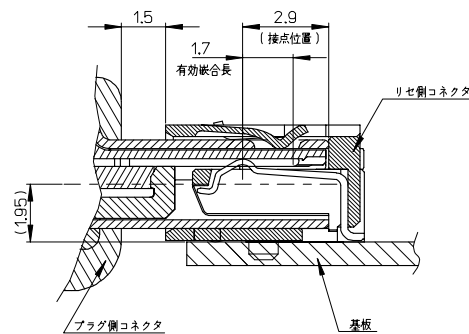
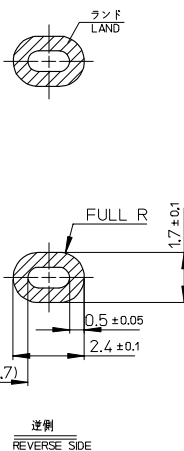
5	51387-0539
極数 CKT.	製品番号 MATERIAL NO.

GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY	SCALE 10:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
10 UNDER	±0.2	DRAWN BY M SHINYAM	DATE 04/06/18	TITLE USB SERIES MINI-B REC. ASS'Y (REFLOW DIP TYPE) -LEAD FREE- MOLEX INCORPORATED	
10 OVER 30 UNDER	±0.25	CHECKED BY H TAKASE	DATE 04/06/18		
30 OVER	±0.3	APPROVED BY J MIYAZAWA	DATE 04/06/18		
ANGULAR	±3°	MATERIAL NO.	DOCUMENT NO.		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		SD-51387-006	
SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		SHEET NO. 1 OF 2	



推薦基板寸法 (SCALE 8:1)

RECOMMENDED PCB PATTERN LAYOUT



コネクタ嵌合図
(SCALE 8:1)

REVISED EC NO. J2007-2931 DRAWN BY AGI CHK'D BY MAEDA APPR. NUKITA	DESCRIPTION 2007/04/19 2007/04/23 2007/04/24	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 10:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	DRAWN BY MSHINYAM	DATE 04/06/18	TITLE USB SERIES MINI-B REC. ASS'Y (REFLOW DIP TYPE) -LEAD FREE-				
		10 OVER 30 UNDER	± 0.25	CHECKED BY HTAKASE	DATE 04/06/18					
		30 OVER	± 0.3	APPROVED BY JMIYAZAW	DATE 04/06/18	MOLEX MOLEX INCORPORATED				
		ANGULAR	± 3 °	MATERIAL NO.						
REV		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHEET 1		SD-51387-006		2 OF 2		
				SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				